

# 15mW Dual Junction VCSEL Chip VC-0940V-015M-52-0B0

# FEATURES

- 940nm single wavelength
- Low wavelength drift
- Dual Junction VCSEL
- Low threshold current
- Small emission area
- Easy to collimate

## **APPLICATIONS**

- Proximity Sensor
- Active optical cables
- Medical applications
- Range finder sensors
- Modulation bandwidth >2Gbps

Part Number	Description		
VC-0940V-015M-52-0B0	15mW Dual Junction VCSEL Chip		

## PRODUCT IDENTIFY

## Code Rules

VC	-	<u>0940</u>	<u>V</u>	-	<u>015</u>	M	-	<u>52</u>	-	<u>0</u>	<u>B</u>	<u>0</u>	
	-	2	3	-	4	5	-	6	-	7	8	9	
													Annex, 0
													Product Version, B = Dual Junction
													Accessories, 0
													PCE, 52%
													Power units, M = milliWatts
													Power value, 15
													Classification, V= design for Vehicle/Airplane
													Wavelength, 940nm
													Header, short form of VSCEL Chip

### I. Absolute maximum ratings

Parameter	Symbol	Rating	Unit
Case Operating Temperature	Top	-40 to +85	°C
Storage Temperature	T <sub>sto</sub>	-40 to +105	°C
Reflow Soldering Temperature	T <sub>sdr</sub>	320°C (10s)	١
Reverse Voltage	Vr	5	V
Maximum Continuous Current	I <sub>max</sub>	20	mA
ESD exposure (Human body) model	ESD	1К	V

Note:

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating



only and functional operation of the device at these or other conditions above those indicated in the operations section for extended periods of time may affect reliability.

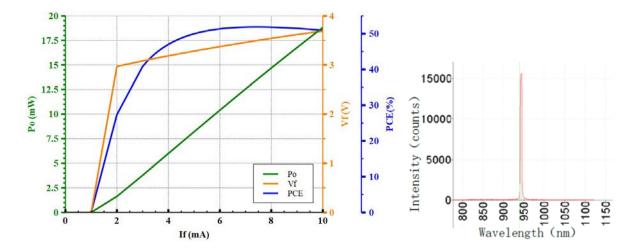
- 2. In its maximum rating diode laser operation could damage its performance or cause potential safety hazard such as equipment failure.
- 3. Electrostatic discharge is the main reason for the laser fault of the diode. Take effective precautions against ESD. When dealing with laser diodes, use the wrist strap, grounding work surface and strict antistatic technology.

### II. Optical-electrical characteristics @25°C Pulse width 0.5ms, Duty cycle1%

Parameters	Symbol	Condition	Min.	Тур.	Max.	Unit
Threshold Current	I <sub>th</sub>		-	2	-	mA
Forward Current	lf		-	8	-	mA
Optical Power	Po	IF=8mA	-	15	18	mW
Laser Forward Voltage	V <sub>f</sub>	I <sub>F</sub> =8mA	-	3.5	-	V
Power conversion efficiency	η	I⊧=8mA	-	52	-	%
Slope efficiency	SE	P₀=15mW	-	2.1	-	W/A
Series Resistance	R	I⊧=8mA	-	78	-	Ω
Peak Wavelength	-	I⊧=8mA	930	940	950	nm
Wavelength-Temp. Drift	Δλ/ΔΤ	I⊧=8mA	-	-	0.07	nm/°C
Beam divergence	FWHM <sub>B</sub>		-	21	-	deg
No. of Emission Aperture			-	1	-	

**Note:** Electro-Optical Characteristic with a package or diffuser would require further evaluation. Values are based on limited sample size and estimated values.

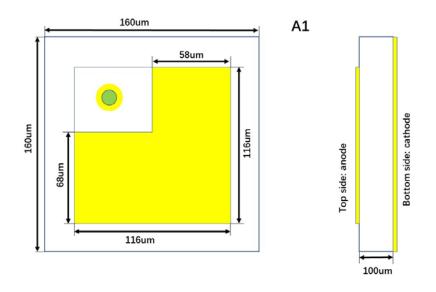
# III. Typical Performance LIV curve and Wavelength





## **IV.** Mechanical Schematics (unit : um)

VC-0940V-015M-52-0B0 with No. of Emission Aperture [1], thickness=100



**Note:** There may be some changes between sample and drawing  $\cdot$  thus  $\cdot$  the actual spec please refer to the sample that you received. And if any inquires please contact us.

### V. Packaging Suggestion

For packaging, the user should use high thermal conductive substrate with AIN or copper; the user also attaches die onto the substrate using high thermal conductive materials such as nanosilver gel or AuSn. The user should have the equipments such as die attachment, wire bonder etc., which should be located in 1000 class clean room. For further assistance in need, please feel free to contact Brightintelligence! We would work with you to solve your issues.

# VI. Treatment and protection measures Soldering precautions

The operator should examine grounding of machines before die attachment; and operator. should wear electrostatic bracelet to prevent die from damaging caused by electrostatic discharging.

### **Storage precautions**

VCSEL bare dies must be stored in Nitrogen gas cabinet with >99% concentration at 20°C.

### VII. Revision History

Revision	Date	Description
V.01	2020/01/12	The first official edition [035C1 <sub>H</sub> ]

**Note:** Brightlaser reserves the right to make modification at any time due to improved design from time to time, the merit behind is to supply the best product possible.